

Dual N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY

V _{DS} (V)	R _{DS(on)} (mΩ)(Typ.)	I _D (A) ^a	Q _g (Typ.)
60	25 at V _{GS} = 10 V	8.9	26 nC
	30 at V _{GS} = 4.5 V		

FEATURES

- DT-Trench Power MOSFET
- 100 % R_g and UIS Tested
- Low RDS(ON)

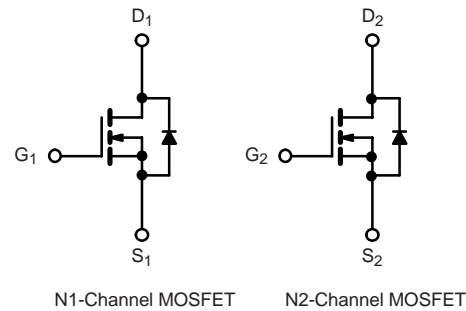
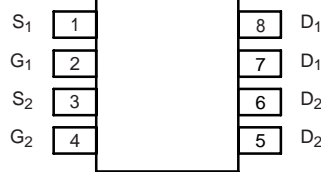
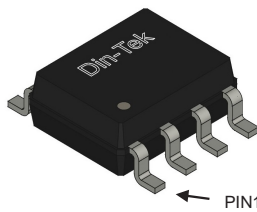
APPLICATIONS

- High Frequency Switching and Synchronous Rectification



RoHS
COMPLIANT

SOP-8 Pin Configuration Top View



ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	± 20	
Continuous Drain Current (T _J = 150 °C) ^a	I _D	T _C = 25 °C	A
		T _C = 100 °C	
Pulsed Drain Current ^b	I _{DM}	30	
Single Avalanche Energy	E _{AS}	20	mJ
Maximum Power Dissipation ^c	P _D	T _C = 25 °C	W
		T _C = 100 °C	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient (PCB Mount) ^d	R _{thJA}	60	°C/W
Junction-to-Case (Drain)	R _{thJC}	26.5	

Notes

- Calculated continuous current based on maximum allowable junction temperature.
- Repetitive rating; pulse width limited by max. junction temperature.
- P_D is based on max. junction temperature, using junction-case thermal resistance.
- The value of R_{thJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.

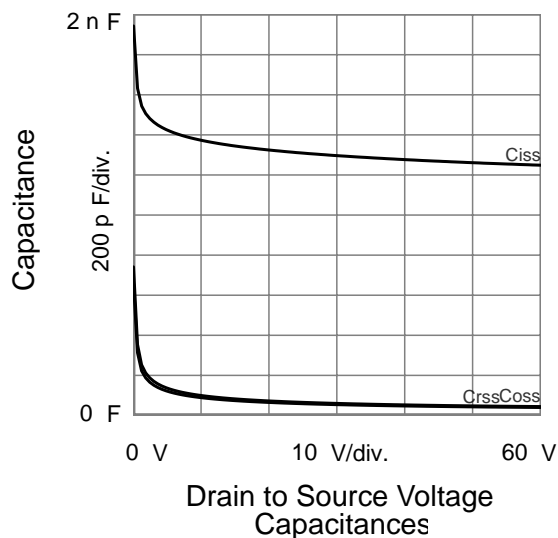
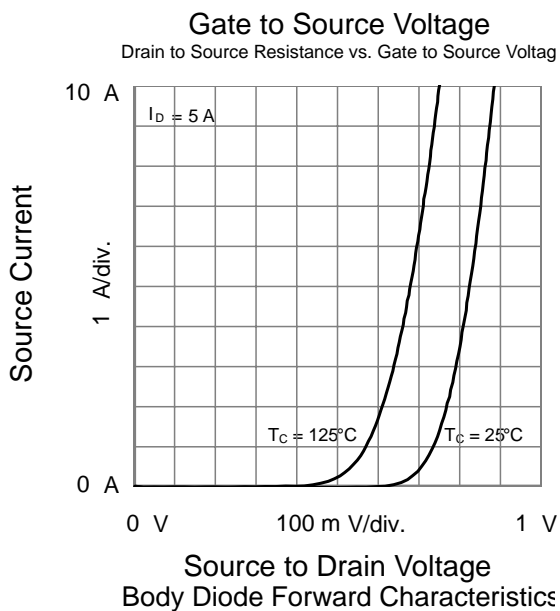
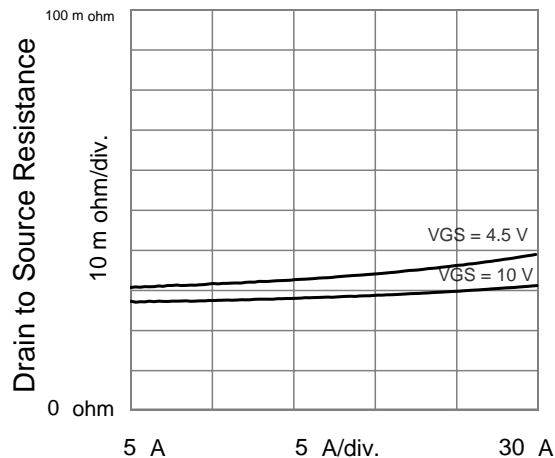
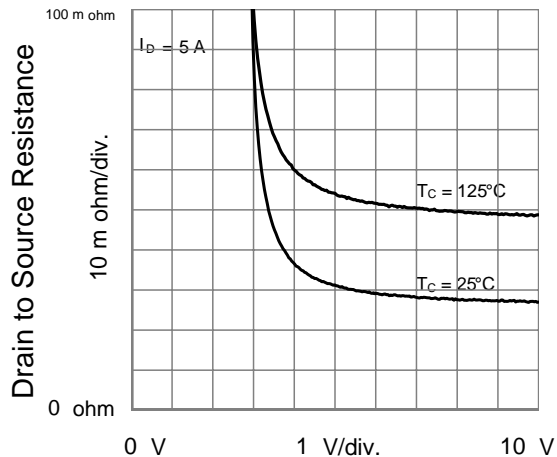
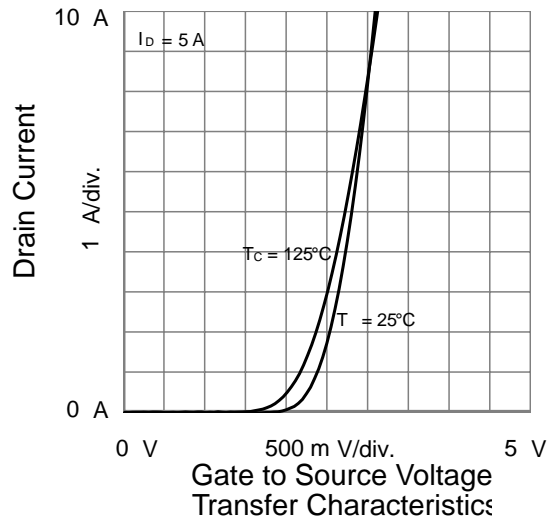
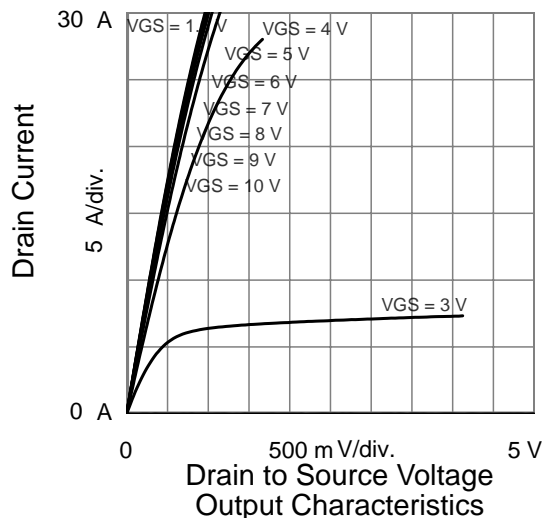
SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	60	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1	-	3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	8.9	-	-	A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 5 A	-	25	35	mΩ
		V _{GS} = 4.5 V, I _D = 5 A	-	30	40	
Forward Transconductance ^a	g _{fs}	V _{DS} = 5 V, I _D = 5 A	-	24	-	S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz	-	1300	-	pF
Output Capacitance	C _{oss}		-	60	-	
Reverse Transfer Capacitance	C _{rss}		-	54	-	
Total Gate Charge ^c	Q _g	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 5 A	-	26	-	nC
Gate-Source Charge ^c	Q _{gs}		-	2.4	-	
Gate-Drain Charge ^c	Q _{gd}		-	4.5	-	
Gate Resistance	R _g	f = 1 MHz	-	2.3	-	Ω
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 30 V, I _D = 4.4 A, R _g = 1 Ω V _{GS} = 10 V, R _L = 6.8 Ω	-	10	-	ns
Rise Time ^c	t _r		-	12	-	
Turn-Off Delay Time ^c	t _{d(off)}		-	25	-	
Fall Time ^c	t _f		-	10	-	
Drain-Source Body Diode Ratings and Characteristics ^b (T_C = 25 °C)						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	8.9	A
Pulsed Current	I _{SM}		-	-	30	A
Forward Voltage ^a	V _{SD}	I _F = 1 A, V _{GS} = 0 V	-	0.6	-	V
Reverse Recovery Time	t _{rr}	I _F = 4.4 A, di/dt = 100 A/μs	-	25	-	ns
Reverse Recovery Charge	Q _{rr}		-	25	-	nC

Notes

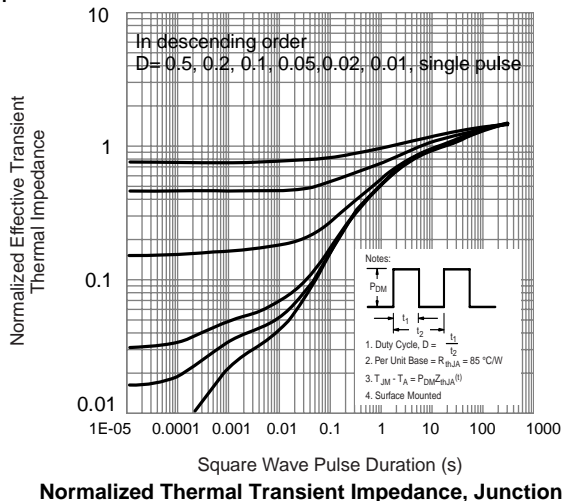
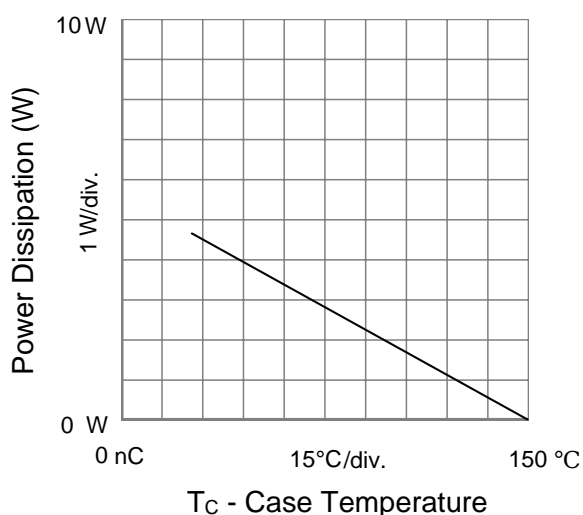
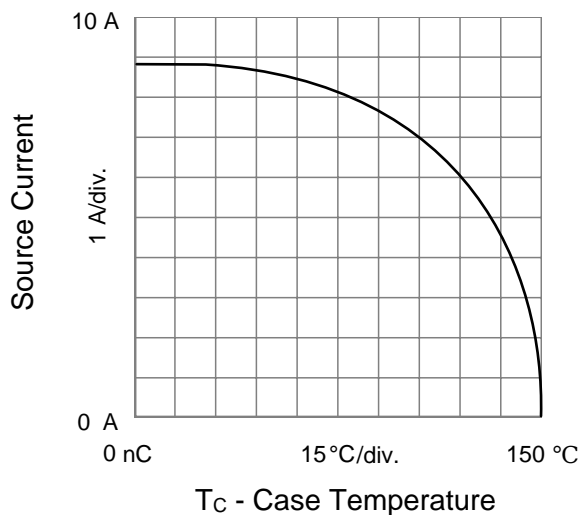
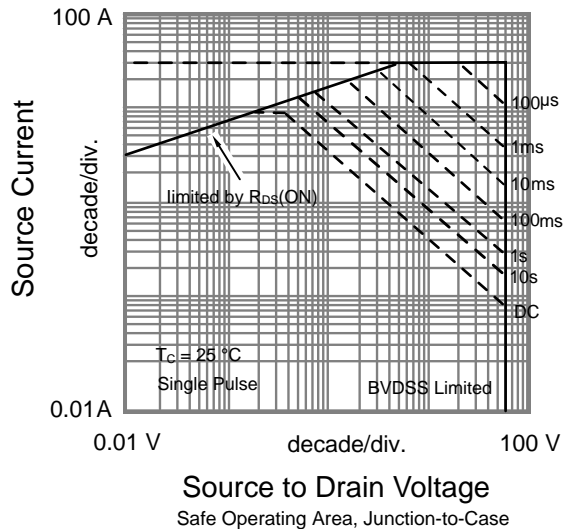
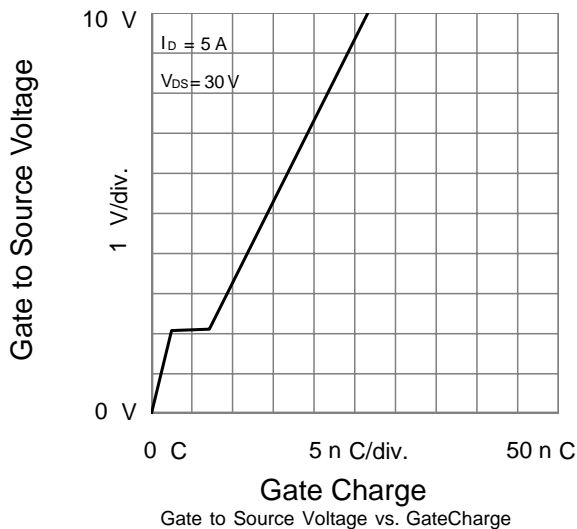
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
 b. Guaranteed by design, not subject to production testing.
 c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

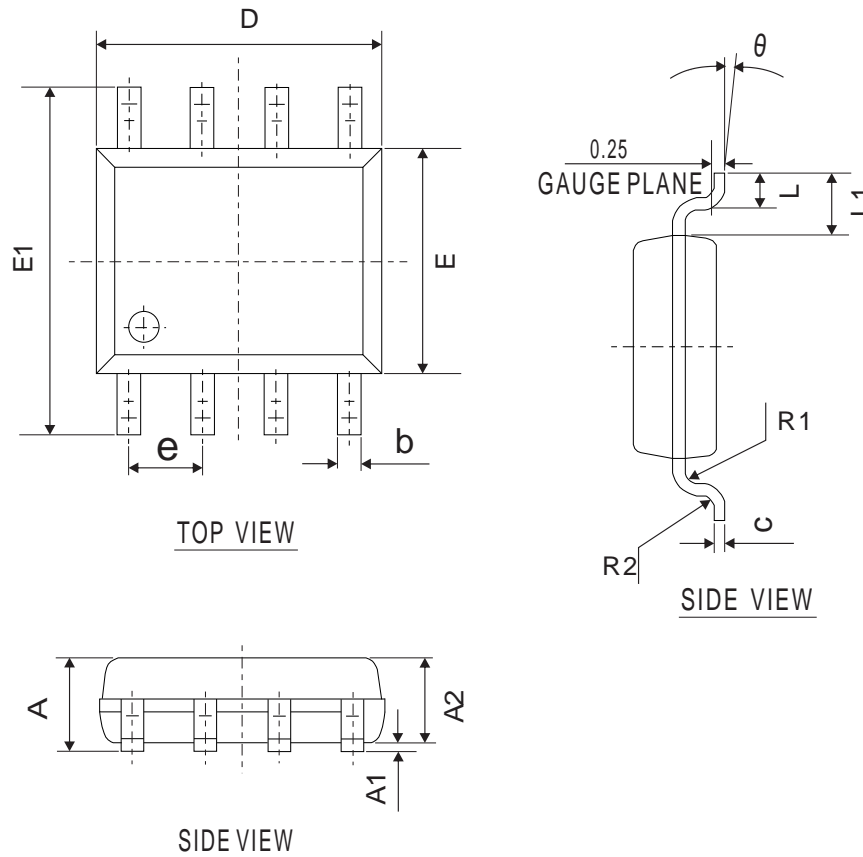
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



SOP-8 PACKGE OUTLINE



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX
A	1.30	1.60	1.85
A1	0.03	0.15	0.28
A2	1.20	1.45	1.70
b	0.26	0.40	0.54
C	0.132	0.203	0.273
D	4.50	4.90	5.30
E	3.50	3.00	4.30
E1	5.50	6.00	6.50
L	0.30	0.70	1.10
θ	2°	4°	6°
L1	1.04REF		
e	1.27BSC		
R1	0.07TYP		
R2	0.07TYP		

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